



Mr. Dan Deisz, Rochester Electronics, Vice President, Design Technology

With over 35 years of semiconductor design experience, Dan Deisz is the Vice President of Design Technology at Rochester Electronics, based out of its Rockville, Maryland, office. In this role, his group performs all authorized product replications and customer-specific design solutions. Daniel is also an active Anti-Counterfeiting Task Force (ACTF) member for the SIA, having trained more than 200 CBP/HSI agents.